

BC817-25 / BC817-40

THERMAL DATA

R _{thj-amb} •	Thermal Resistance Junction-Ambient	Max	500	°C/W
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• Device mounted on a PCB area of 1 cm²

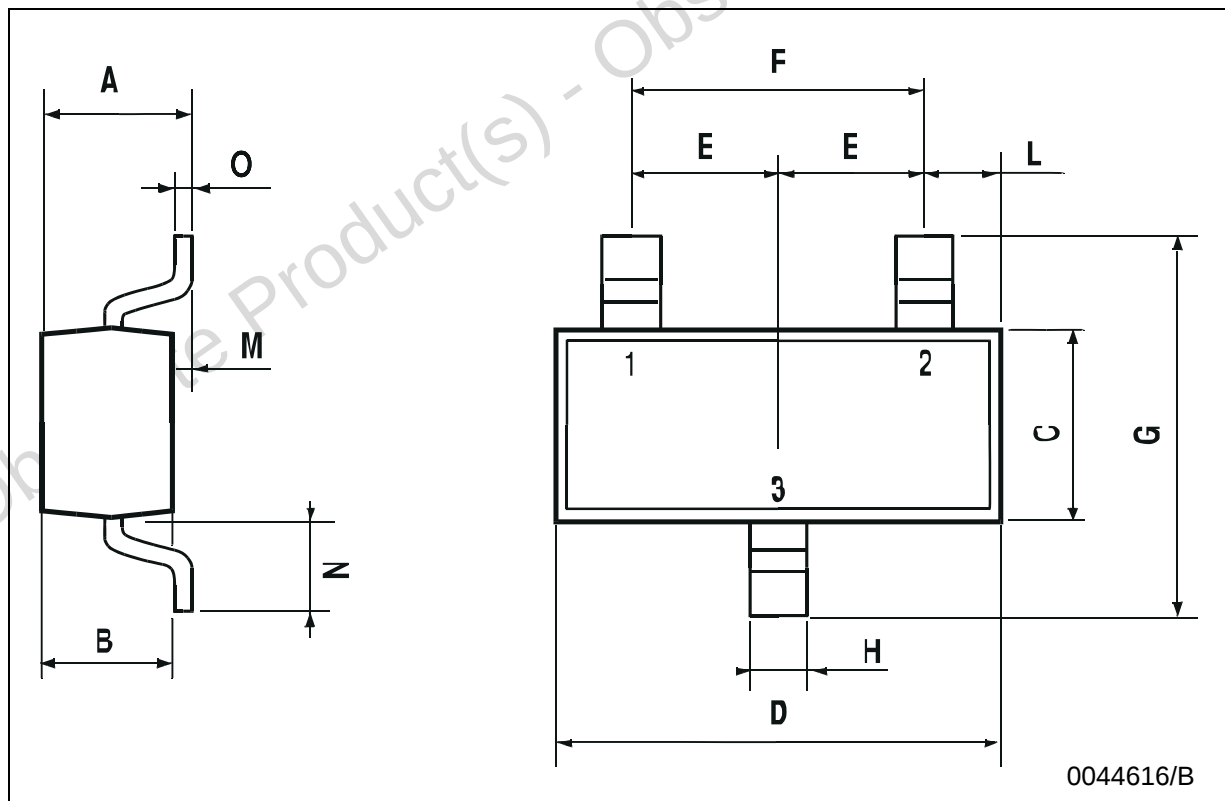
ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I _{CBO}	Collector Cut-off Current (I _E = 0)	V _{CB} = 20 V V _{CB} = 20 V T _C = 150°C			100 5	nA μA
I _{EBO}	Emitter Cut-off Current (I _E = 0)	V _{EB} = 5 V			100	nA
V _{(BR)CEO} *	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = 10 mA	45			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 500 mA I _B = 50 mA			0.7	V
V _{BE(on)} *	Base-Emitter On Voltage	I _C = 500 mA V _{CE} = 1 V			1.2	V
h _{FE} *	DC Current Gain	I _C = 100 mA V _{CE} = 1 V for BC817-25 for BC817-40	160 250		400 600	
f _T	Transition Frequency	I _C = 10 mA V _{CE} = 5 V f = 100 MHz	100			MHz
C _{CBO}	Collector-Base Capacitance	I _E = 0 V _{CB} = 10 V f = 1 MHz		8		pF

* Pulsed: Pulse duration = 300 μs, duty cycle ≤ 2 %

SOT-23 MECHANICAL DATA

DIM.	mm			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	0.85		1.1	33.4		43.3
B	0.65		0.95	25.6		37.4
C	1.20		1.4	47.2		55.1
D	2.80		3	110.2		118
E	0.95		1.05	37.4		41.3
F	1.9		2.05	74.8		80.7
G	2.1		2.5	82.6		98.4
H	0.38		0.48	14.9		18.8
L	0.3		0.6	11.8		23.6
M	0		0.1	0		3.9
N	0.3		0.65	11.8		25.6
O	0.09		0.17	3.5		6.7



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